







**TPS65263** 

ZHCSCV2C - JUNE 2014 - REVISED MAY 2023

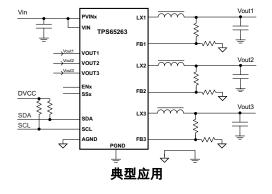
# TPS65263 具有 I<sup>2</sup>C 控制型动态电压调节功能的 4.5V 至 18V 输入电压、3A/2A/2A 输出电流三路同步降压转换器

## 1 特性

- 工作输入电压范围 4.5V 至 18V, 连续输出电流
- 通过 I<sup>2</sup>C 控制型 7 位 VID 可为每个降压转换器实 现可编程输出电压范围为 0.68V 至 1.95V, 阶跃为 10mV
- I<sup>2</sup>C 控制型 VID 电压转换压摆率
- 通过 I<sup>2</sup>C 可针对每个降压转换器读回电源正常状 态,发出过流警告
- 通过 I<sup>2</sup>C 读回芯片温度警告
- 具有支持标准模式 (100kHz) 和快速模式 (400kHz) 的 I<sup>2</sup>C 兼容接口
- 反馈基准电压为 0.6V ±1%
- 600kHz 固定频率
- 针对每次降压的专用使能引脚和软启动引脚
- 热过载保护

## 2 应用

- 数字电视 (DTV) 液晶显示屏 (LCD) 面板
- 机顶盒
- 家庭网关和接入点网络
- 监控



# 3 说明

TPS65263 整合了三路同步降压转换器,支持 4.5V 至 18V 宽范围输入电压,该电压范围包括大部分中间 总线关闭电压为 5、9、12 或 15V 的电源总线或电 池。这款转换器具有恒定频率峰值电流模式,专用于简 化应用,同时方便设计人员根据目标应用来优化系统。 该器件工作频率为 600kHz, buck1 与 buck2 和 buck3 之间 180° 异相(buck2 和 buck3 同相运行)。

每个降压转换器的初始启动电压都可通过外部反馈电阻 设定。可使用 I<sup>2</sup>C 受控 7 位 VID 对每个降压转换器的 输出电压进行动态调整,范围为 0.68V 至 1.95V,步 长为 10mV。可通过 I2C 总线 3 位控制对 VID 电压 转换率进行编程,以优化 VID 电压转换期间的过冲/下 冲。

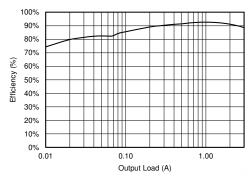
TPS65263 中的每个降压转换器都可通过 I<sup>2</sup>C 加以控 制,从而执行以下操作:启用/禁用输出电压、设置脉 冲跳跃模式 (PSM) 或轻负载条件下的强制持续电流模 式 (FCC) 以及读取电源正常状态、过流警告和温度警 告。

TPS65263 具有过压保护、过流保护、短路保护和过热 保护功能。

## 封装信息<sup>(1)</sup>

器件型号	封装	封装尺寸(标称值)
TPS65263	RHB ( VQFN , 32 )	5.00mm × 5.00mm

要了解所有可用封装,请见数据表末尾的可订购产品附录。



 $V_{IN} = 12V \; ; \; V_{OUT} = 3.3V$ 

效率与输出负载之间的关系



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注:以前版本的页码可能与当前版本的页码不同			

	:以前版本的页码可能与当前版本的页码不同	
CI	hanges from Revision B (May 2023) to Revision C (May 2023)	Page
•	Changed the value of capacitor from V7V pin to power ground in V7V Low Dropout Regulator and Bootstrap.	20
CI	hanges from Revision A (September 2014) to Revision B (May 2023)	Page
•	更新了整个文档中的表格、图和交叉参考的编号格式	1
	Changed the description of V7V pin in 表 6-1	
	Renamed Handling Ratings to ESD Ratings	
	Moved the storage temperature row in the <i>ESD Ratings</i> table to the <i>Absolute Maximum Ratings</i> table Changed the recommended value of capacitor from V7V pin to power ground in <i>V7V Low Dropout Reand Bootstrap</i>	6 gulator
•	Changed all instances of legacy terminology to controller and target where I <sup>2</sup> C is mentioned	
	Changed the recommended value of C9 in the typical application schematic	
CI	hanges from Revision * (June 2014) to Revision A (September 2014)	Page
_	· 将器件状态从"产品预发布"更改为"量产数据"	

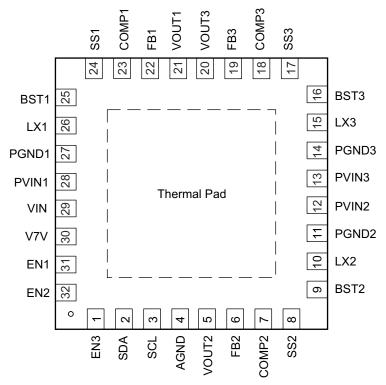


# **5 Device Comparison Table**

PART NUMBER	DESCRIPTION	COMMENTS
TPS65261/-1	4.5 to 18 V, triple bucks with input voltage power failure indicator	Triple bucks 3-A/2-A/2-A output current, features an open drain RESET signal to monitor input power failure, automatic power sequencing
TPS65262/-1	4.5 to 18 V, triple bucks with dual adjustable LDOs	Triple bucks 3-A/1-A/1-A output current, automatic power sequencing. dual LDOs: TPS65262, 200 mA/100 mA; TPS65262-1, 350 mA/150 mA
TPS65287	4.5 to 18 V, triple bucks with power switch and push button control	Triple bucks 3-A/2-A/2-A output current, up to 2.1-A USB power with over current setting by external resistor, push button control for intelligent system power-on/power-off operation
TPS65288	4.5 to 18 V, triple bucks with dual power switches	Triple bucks 3-A/2-A/2-A output current, 2 USB power switches current limiting at typical 1.2 A (0.8, 1.0, 1.4, 1.6, 1.8, 2.0, 2.2 A available with manufacture trim options)



# **6 Pin Configuration and Functions**



(There is no electric signal down bonded to thermal pad inside IC. Exposed thermal pad must be soldered to PCB for optimal thermal performance.)

# 图 6-1. RHB Package 32 Pin Top View

表 6-1. Pin Functions

PIN	V	DECODIDATION			
NAME	NO.	DESCRIPTION			
EN3	1	Enable for buck3. Float to enable. Can use this pin to adjust the input undervoltage lockout (UVLO) of buck3 with a resistor divider.			
SDA	2	I <sup>2</sup> C interface data pin			
SCL	3	I <sup>2</sup> C interface clock pin			
AGND	4	Analog ground common to buck controllers and other analog circuits. It must be routed separately from high current power grounds to the (–) terminal of bypass capacitor of input voltage VIN.			
VOUT2	5	Buck2 output voltage sense pin.			
FB2	6	Feedback Kelvin sensing pin for buck2 output voltage. Connect this pin to buck2 resistor divider.			
COMP2	7	Error amplifier output and Loop compensation pin for buck2. Connect a series resistor and capacitor to compensate the control loop of buck2 with peak current PWM mode.			
SS2	8	Soft-start and tracking input for buck2. An internal 5uA pullup current source is connected to this pin. The soft-start time can be programmed by connecting a capacitor between this pin and ground.			
BST2	9	Boot strapped supply to the high side floating gate driver in buck2. Connect a capacitor (recommend 47nF) from BST2 pin to LX2 pin.			
LX2	10	Switching node connection to the inductor and bootstrap capacitor for buck2. The voltage swing at this pin is from a diode voltage below the ground up to PVIN2 voltage.			
PGND2	11	Power ground connection of buck2. Connect PGND2 pin as close as practical to the (–) terminal of PVIN2 input ceramic capacitor.			
PVIN2	12	Input power supply for buck2. Connect PVIN2 pin as close as practical to the (+) terminal of an input ceramic capacitor (suggest 10 µF).			

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# 表 6-1. Pin Functions (continued)

PIN		DESCRIPTION				
NAME	NO.	DESCRIPTION				
PVIN3	13	Input power supply for buck3. Connect PVIN3 pin as close as practical to the $(+)$ terminal of an input ceramic capacitor (suggest 10 $\mu$ F).				
PGND3	14	Power ground connection of buck3. Connect PGND3 pin as close as practical to the (–) terminal of PVIN3 input ceramic capacitor.				
LX3	15	Switching node connection to the inductor and bootstrap capacitor for buck3. The voltage swing at this pin is from a diode voltage below the ground up to PVIN3 voltage.				
BST3	16	Boot strapped supply to the high side floating gate driver in buck3. Connect a capacitor (recommend 47 nF) from BST3 pin to LX3 pin.				
SS3	17	Soft-start and tracking input for buck3. An internal 5-µA pullup current source is connected to this pin. The soft-start time can be programmed by connecting a capacitor between this pin and ground.				
COMP3	18	Error amplifier output and Loop compensation pin for buck3. Connect a series resistor and capacitor to compensate the control loop of buck3 with peak current PWM mode.				
FB3	19	Feedback Kelvin sensing pin for buck3 output voltage. Connect this pin to buck3 resistor divider.				
VOUT3	20	Buck3 output voltage sense pin.				
VOUT1	21	Buck1 output voltage sense pin.				
FB1	22	Feedback Kelvin sensing pin for buck1 output voltage. Connect this pin to buck1 resistor divider.				
COMP1	23	Error amplifier output and Loop compensation pin for buck1. Connect a series resistor and capacitor to compensate the control loop of buck1 with peak current PWM mode.				
SS1	24	Soft-start and tracking input for buck1. An internal 5-µA pullup current source is connected to this pin. The soft-start time can be programmed by connecting a capacitor between this pin and ground.				
BST1	25	Boot strapped supply to the high side floating gate driver in buck1. Connect a capacitor (recommend 47 nF) from BST1 pin to LX1 pin.				
LX1	26	Switching node connection to the inductor and bootstrap capacitor for buck1. The voltage swing at this pin is from a diode voltage below the ground up to PVIN1 voltage.				
PGND1	27	Power ground connection of Buck1. Connect PGND1 pin as close as practical to the (–) terminal of PVIN1 input ceramic capacitor.				
PVIN1	28	Input power supply for buck1. Connect PVIN1 pin as close as practical to the (+) terminal of an input ceramic capacitor (suggest 10 µF).				
VIN	29	Buck controller power supply.				
V7V	30	Internal LDO for gate driver and internal controller. Connect a 10-µF capacitor from the pin to power ground.				
EN1	31	Enable for buck1. Float to enable. Can use this pin to adjust the input UVLO of buck1 with a resistor divider.				
EN2	32	Enable for buck2. Float to enable. Can use this pin to adjust the input UVLO of buck2 with a resistor divider.				
PAD	_	There is no electric signal down bonded to thermal pad inside IC. Exposed thermal pad must be soldered to PCB for optimal thermal performance.				



# 7 Specifications

# 7.1 Absolute Maximum Ratings

over operating free-air temperature (unless otherwise noted) (1)

		MIN	MAX	UNIT
	PVIN1, PVIN2, PVIN3,VIN	-0.3	20	
	LX1, LX2, LX3 (maximum withstand voltage transient <20 ns)	-1.0	20	
Voltage	BST1, BST2, BST3 referenced to LX1, LX2, LX3 pins respectively	-0.3	7	V
voltage	EN1, EN2, EN3, V7V, VOUT1, VOUT2, VOUT3, SCL, SDA	-0.3	7	\ \ \
	FB1, FB2, FB3, COMP1, COMP2, COMP3, SS1, SS2, SS3	-0.3	3.6	
	AGND, PGND1, PGND2, PGND3	-0.3	0.3	
TJ	Operating junction temperature	-40	125	°C
T <sub>stg</sub>	Storage temperature range	-55	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

			MIN	MAX	UNIT
V	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	-2000	2000	V
V <sub>(ESD)</sub>	discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	-500	500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

# 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
	PVIN1, PVIN2, PVIN3,VIN	4.5	18	
	LX1, LX2, LX3 (Maximum withstand voltage transient <20 ns)	-0.8	18	
Voltage	BST1, BST2, BST3 referenced to LX1, LX2, LX3 pins respectively	-0.1	6.8	V
	EN1, EN2, EN3, V7V, VOUT1, VOUT2, VOUT3, SCL, SDA	-0.1	6.3	
	FB1, FB2, FB3, COMP1, COMP2, COMP3, SS1, SS2, SS3	-0.1	3	
T <sub>A</sub>	Operating ambient temperature	-40	85	°C
TJ	Operating junction temperature	-40	125	°C

#### 7.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>		LIMIT
	THERMAL METRIC(**)	RHB (32 PINS)	UNIT
R <sub>0JA</sub>	Junction-to-ambient thermal resistance	33.3	
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	25.7	
$R_{\theta JB}$	Junction-to-board thermal resistance	7.4	°C/W
ΨЈТ	Junction-to-top characterization parameter	0.3	C/VV
ΨЈВ	Junction-to-board characterization parameter	7.3	
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	2.1	

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

Product Folder Links: *TPS65263* 

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## 7.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

э гэ. э <b>р</b> э гэ	g free-air temperature range (unless other	TEST CONDITIONS	MIN	TYP	MAX	UNIT
INPUT SUPPLY						
VIN	Input voltage range		4.5		18	V
		VIN rising	4	4.25	4.5	V
UVLO	VIN undervoltage lockout	VIN falling	3.5	3.75	4	V
	· · · · · · · · · · · · · · · · · · ·	Hysteresis		500		mV
IDD <sub>SDN</sub>	Shutdown supply current	EN1 = EN2 = EN3 = 0 V		8		μA
IDD <sub>Q_NSW</sub>		EN1 = EN2 = EN3 = 5 V, FB1 = FB2 = FB3 = 0.8 V		740		μA
IDD <sub>Q_NSW1</sub>	Input quiescent current without buck1/2/3	EN1 = 5 V, EN2 = EN3 = 0 V, FB1 = 0.8 V		360		μA
IDD <sub>Q_NSW2</sub>	switching	EN2 = 5 V, EN1 = EN3 = 0 V, FB2 = 0.8 V		380		μA
IDD <sub>Q_NSW3</sub>		EN3 = 5 V, EN1 = EN2 = 0 V, FB3 = 0.8 V		380		μA
V <sub>7V</sub>	V7V LDO output voltage	V <sub>7V</sub> load current = 0 A	6	6.3	6.6	V
I <sub>OCP_V7V</sub>	V7V LDO current limit			185		mA
	TAGE REFERENCE					
.,	- " . "	V <sub>COMP</sub> = 1.2 V, T <sub>J</sub> = 25°C	0.595	0.6	0.605	V
$V_{FB}$	Feedback voltage	V <sub>COMP</sub> = 1.2 V, T <sub>J</sub> = -40°C to 125°C	0.594	0.6	0.606	V
V <sub>LINEREG_BUCK</sub>	Line regulation-DC <sup>(1)</sup>	I <sub>OUT1</sub> = 1.5 A, I <sub>OUT2</sub> = 1 A, I <sub>OUT3</sub> = 1 A, 5 V < PVINx < 18 V		0.002		%/V
V <sub>LOADREG</sub> BUCK	Load regulation-DC <sup>(1)</sup>	I <sub>OUTx</sub> = (10-100%) × I <sub>OUTx max</sub>		0.02		%/A
BUCK1, BUCK2,	, BUCK3					
V <sub>ENXH</sub>	EN1/2/3 high level input voltage			1.2	1.26	V
V <sub>ENXL</sub>	EN1/2/3 low level input voltage		1.1	1.15		V
I <sub>ENX1</sub>	EN1/2/3 pullup current	ENx = 1 V		3.8		μA
I <sub>ENX2</sub>	EN1/2/3 pullup current	ENx = 1.5 V		6.8		μA
I <sub>ENhys</sub>	Hysteresis current			3		μA
I <sub>SSX</sub>	Soft start charging current		4.3	5	6	μA
T <sub>ON_MIN</sub>	Minimum on time			80	100	ns
G <sub>m_EA</sub>	Error amplifier trans-conductance	–2 μA < I <sub>COMPX</sub> < 2 μA		300		μS
G <sub>m PS1/2/3</sub>	COMP1/2/3 voltage to inductor current Gm <sup>(1)</sup>	I <sub>LX</sub> = 0.5 A		7.4		A/V
I <sub>LIMIT1</sub>	Buck1 peak inductor current limit		4.5	5.5	6.5	Α
I <sub>LIMITSOURCE1</sub>	Buck1 low side source current limit			4.4		Α
I <sub>LIMITSINK1</sub>	Buck1 low side sink current limit			1.3		
I <sub>LIMIT2/3</sub>	buck2/3 peak inductor current limit		2.6	3.3	4	Α
I <sub>LIMITSOURCE2/3</sub>	Buck2/3 low side source current limit			2.5		
I <sub>LIMITSINK2/3</sub>	Buck2/3 low side sink current limit			1		Α
Rdson_HS1	Buck1 high-side switch resistance	VIN = 12 V		105		mΩ
Rdson_LS1	Buck1 low-side switch resistance	VIN = 12 V		65		mΩ
Rdson_HS2	Buck2 high-side switch resistance	VIN = 12 V		140		mΩ
Rdson_LS2	Buck2 low-side switch resistance	VIN = 12 V		90		mΩ
Rdson_HS3	Buck3 high-side switch resistance	VIN = 12 V		140		mΩ
Rdson_LS3	Buck3 low-side switch resistance	VIN = 12 V		90		mΩ
HICCUP TIMING	i	·	<u> </u>			
T <sub>Hiccup_wait</sub>	Over current wait time <sup>(1)</sup>			0.5		ms
T <sub>Hiccup_re</sub>	Hiccup time before restart <sup>(1)</sup>			14		ms
OSCILLATOR		'				
F <sub>SW</sub>	Switching frequency		550	600	650	kHz



# 7.5 Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
THERMAL PRO	TECTION				
T <sub>TRIP_OTP</sub>	Thermal protection trip point <sup>(1)</sup>	Temperature rising		160	°C
T <sub>HYST_OTP</sub>	Thermal protection Hysteresis <sup>(1)</sup>	Hysteresis		20	°C
I <sup>2</sup> C INTERFACE			·		
Addr	Address <sup>(2)</sup>	0x60H			
V <sub>IH</sub> SDA,SCL	Input high voltage			2	V
V <sub>IL</sub> SDA,SCL	Input low voltage		0.4		V
I <sub>I</sub>	Input current	SDA, SCL, V <sub>I</sub> = 0.4 to 4.5 V	-10	10	μA
V <sub>OL</sub> SDA	SDA output low voltage	SDA open drain, I <sub>OL</sub> = 4 mA		0.4	V
$f_{(SCL)}$	Maximum SCL clock frequency <sup>(2)</sup>		400		kHz
t <sub>BUF</sub>	Bus free time between a STOP and START condition <sup>(2)</sup>		1.3		μs
t <sub>HD_STA</sub>	Hold time (repeated) START condition <sup>(2)</sup>		0.6		μs
t <sub>su_sto</sub>	Setup time for STOP condition <sup>(2)</sup>		0.6		μs
t <sub>LOW</sub>	LOW Period of the SCL Clock <sup>(2)</sup>		1.3		μs
t <sub>HIGH</sub>	HIGH period of the SCL clock <sup>(2)</sup>		0.6		μs
t <sub>SU_STA</sub>	Setup time for a repeated START condition <sup>(2)</sup>		0.6		μs
t <sub>SU_DAT</sub>	Data setup time <sup>(2)</sup>		0.1		μs
t <sub>HD_DAT</sub>	Data hold time <sup>(2)</sup>		0	0.9	μs
t <sub>RCL</sub>	Rise time of SCL signal <sup>(2)</sup>	Capacitance of one bus line (pF)	20 + 0.1CB	300	ns
t <sub>RCL1</sub>	Rise time of SCL signal after a repeated START condition and after an acknowledge BIT <sup>(2)</sup>	Capacitance of one bus line (pF)	20 + 0.1CB	300	ns
t <sub>FCL</sub>	Fall time of SCL signal <sup>(2)</sup>	Capacitance of one bus line (pF)	20 + 0.1CB	300	ns
t <sub>RDA</sub>	Rise time of SDA signal <sup>(2)</sup>	Capacitance of one bus line (pF)	20 + 0.1CB	300	ns
t <sub>FDA</sub>	Fall time of SDA signal <sup>(2)</sup>	Capacitance of one bus line (pF)	20 + 0.1CB	300	ns
Св	Capacitance of bus line(SCL and SDA)(2)			400	pF

<sup>(1)</sup> Lab validation result.

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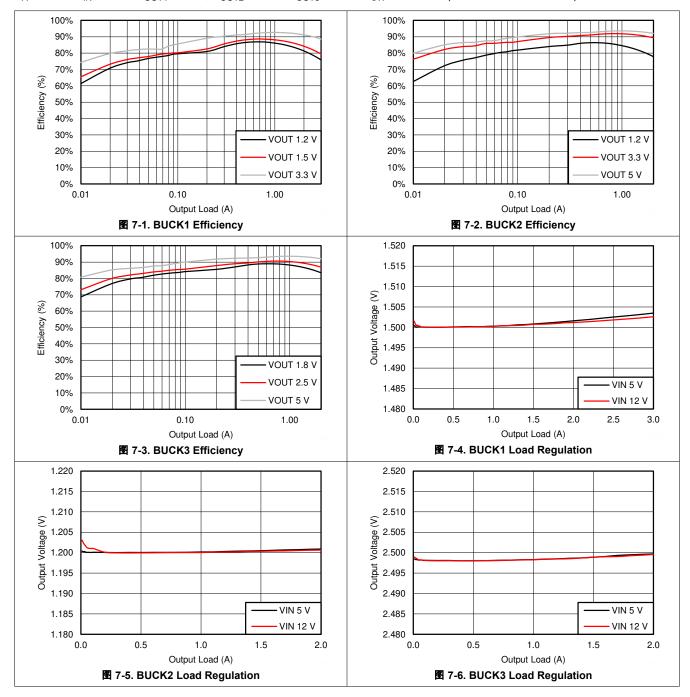
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<sup>(2)</sup> Not production tested.



# 7.6 Typical Characteristics

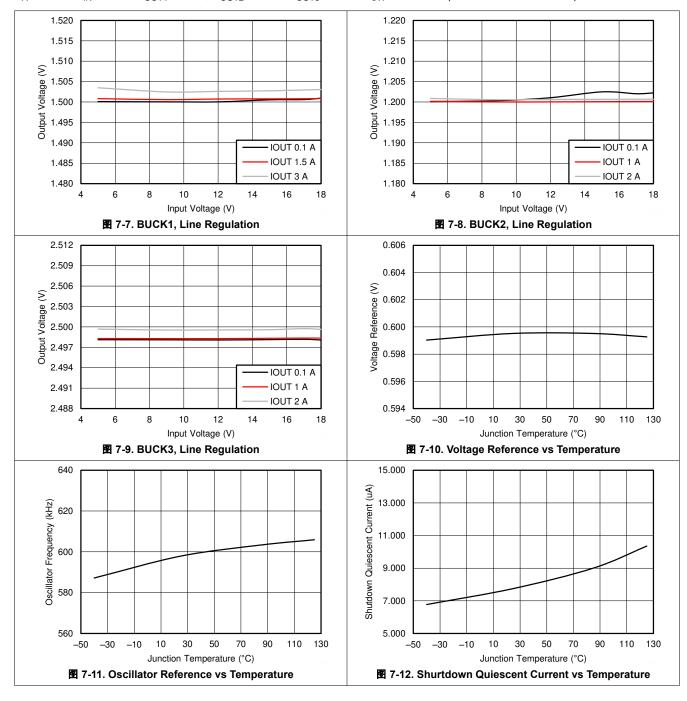
 $T_A = 25$ °C,  $V_{IN} = 12$  V,  $V_{OUT1} = 1.5$  V,  $V_{OUT2} = 1.2$  V,  $V_{OUT3} = 2.5$  V,  $F_{SW} = 600$  kHz (unless otherwise noted)





## 7.6 Typical Characteristics (continued)

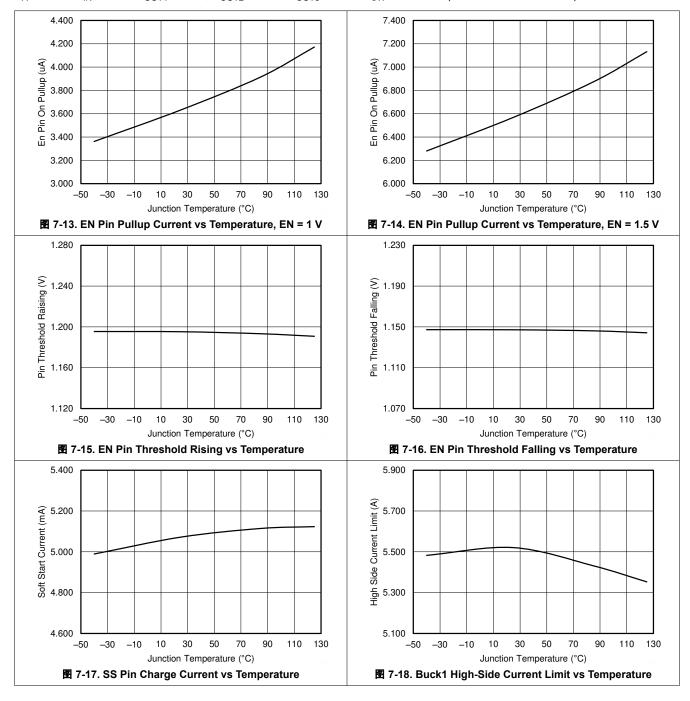
 $T_A = 25$ °C,  $V_{IN} = 12$  V,  $V_{OUT1} = 1.5$  V,  $V_{OUT2} = 1.2$  V,  $V_{OUT3} = 2.5$  V,  $F_{SW} = 600$  kHz (unless otherwise noted)





# 7.6 Typical Characteristics (continued)

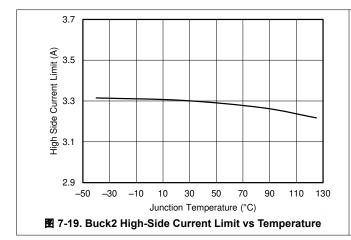
 $T_A = 25^{\circ}C$ ,  $V_{IN} = 12$  V,  $V_{OUT1} = 1.5$  V,  $V_{OUT2} = 1.2$  V,  $V_{OUT3} = 2.5$  V,  $F_{SW} = 600$  kHz (unless otherwise noted)

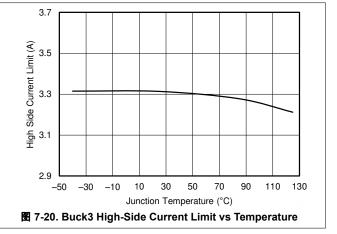




# 7.6 Typical Characteristics (continued)

 $T_A = 25^{\circ}C$ ,  $V_{IN} = 12$  V,  $V_{OUT1} = 1.5$  V,  $V_{OUT2} = 1.2$  V,  $V_{OUT3} = 2.5$  V,  $F_{SW} = 600$  kHz (unless otherwise noted)





Product Folder Links: TPS65263



# 8 Detailed Description

#### 8.1 Overview

The TPS65263 is a monolithic triple synchronous step-down (buck) converter with 3-A/2-A/2-A output currents. A wide 4.5- to 18-V input supply voltage range encompasses most intermediate bus voltages operating off 5-, 9-, 12-, or 15-V power bus. The feedback voltage reference for each buck is 0.6 V. Each buck is independent with dedicated enable, soft-start and loop compensation pins.

The TPS65263 is equipped with  $I^2C$  compatible bus for communication with SoC to control buck converters. Through  $I^2C$  interface, SoC can enable or disable the buck converters, set output voltage and read status registers. External feedback divider resistors can set the initial start-up voltage of the buck regulators. After the voltage identification VID DAC is updated via the  $I^2C$ , output voltage of the buck regulators can be independently programmed with 7 bits VID from 0.68 to 1.95 V in 10-mV voltage step resolution. Output voltage of the buck regulators transition begins after the  $I^2C$  interface receives the command for GO bit in command register.

In light loading condition, the converter will automatically operate in pulse skipping mode (PSM) to save power. The PSM can be disabled through I<sup>2</sup>C so that the converter operates at continuous current mode (CCM) at light load with a fixed frequency for optimized output ripple.

The TPS65263 implements a constant frequency, peak current mode control that simplifies external loop compensation. The device operates in fixed 600 kHz. The switch clock of buck1 is 180° out-of-phase operation from the clock of buck2 and buck3 channels to reduce input current ripple, input capacitor size and power supply induced noise.

The TPS65263 is designed for safe monotonic startup into pre-biased loads. The default start up is when VIN is typically 4.25 V. The ENx pin also can be used to adjust the input voltage UVLO with an external resistor divider. In addition, the ENx pin has an internal 3.8-μA current source, so the EN pin can be floating for automatically powering up the converters.

The TPS65263 reduces the external component count by integrating the bootstrap circuit. The bias voltage for the integrated high-side MOSFET is supplied by a capacitor between the BST and LX pins. A UVLO circuit monitors the bootstrap capacitor voltage VBST-VLX in each buck. When VBST-VLX voltage drops to the threshold, LX pin is pulled low to recharge the bootstrap capacitor. The TPS65263 can operate at 100% duty cycle as long as the bootstrap capacitor voltage is higher than the BOOT-LX UVLO threshold which is typically 2.1 V.

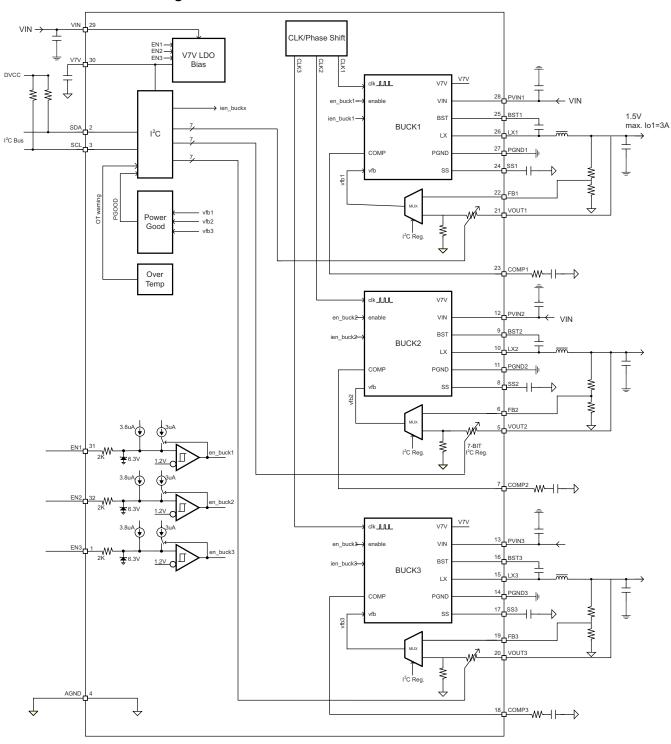
The TPS65263 has power good comparators with hysteresis, which monitor the output voltages through internal feedback voltages. I<sup>2</sup>C can read the power good status with commanding register.

The SS (soft start/tracking) pin is used to minimize inrush currents or provide power supply sequencing during power up. A small value capacitor or resistor divider is connected the pin for soft start or voltage tracking.

The TPS65263 is protected from overload and over temperature fault conditions. The converter minimizes excessive output overvoltage transients by taking advantage of the power good comparator. When the output is over, the high-side MOSFET is turned off until the internal feedback voltage is lower than 105% of the 0.6-V reference voltage. The TPS65263 implements both high-side MOSFET overload protection and bidirectional low-side MOSFET overload protections to avoid inductor current runaway. If the overcurrent condition has lasted for more than the OC wait time (0.5ms typical), the converter will shut down and re-start after the hiccup time (14ms typical). The TPS65263 shuts down if the junction temperature is higher than thermal shutdown trip point. When the junction temperature drops 20°C typically below the thermal shutdown trip point, the TPS65263 will be restarted under control of the soft start circuit automatically.



# 8.2 Functional Block Diagram



#### 8.3 Feature Description

#### 8.3.1 Adjusting the Output Voltage

The output voltage of each buck is set with a resistor divider from the output of buck to the FB pin. TI recommends to use 1% tolerance or better resistors.

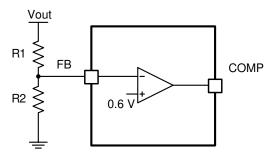


图 8-1. Voltage Divider Circuit

$$R_2 = R_1 \times \frac{0.6}{V_{out} - 0.6} \tag{1}$$

To improve efficiency at light loads consider using larger value resistors. If the values are too high, the regulator is more sensitive to noise. The recommended resistor values are shown in 表 8-1.

表 8-1. Output Resistor Divider Selection

OUTPUT VOLTAGE (V)	R1 (kΩ)	R2 (kΩ)					
1	10	15					
1.2	10	10					
1.5	15	10					
1.8	20	10					
2.5	31.6	10					
3.3	45.3	10					
3.3	22.6	4.99					
5	73.2	10					
5	36.5	4.99					

The output voltage of buck converter can be dynamically scaled by  $I^2C$  controlled 7-bit register VOUTx\_SEL. Before  $I^2C$  communication, the output voltage is set with the resistor divider from the output of buck to the FB pin. When GO bit is set to 1 through  $I^2C$  interface, the buck converter switches external resistor divider to the internal resistor divider as shown in 8 8-2. The output voltage can be selected among 128 voltages with voltage identifications (VID) shown in 8 8-2. The output voltage range of dynamic voltage scaling is 0.68 to 1.95 V with 10-mV resolution of each voltage step.



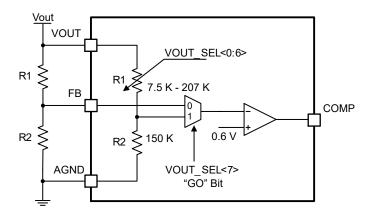


图 8-2. Voltage Divider Circuit

表 8-2. Vout Output Voltage Setting

OUT_SEL VouT (Y)         VOUT_SEL VouT (Y)         VOUT_SEL VouT (Y)         VOUT_SEL VouT (Y)         VOUT_SEL VOU	衣 8-2. Vout Output voltage Setting										
1         0.69         21         1.01         41         1.33         61         1.65           2         0.7         22         1.02         42         1.34         62         1.66           3         0.71         23         1.03         43         1.35         63         1.67           4         0.72         24         1.04         44         1.36         64         1.68           5         0.73         25         1.05         45         1.37         65         1.69           6         0.74         26         1.06         46         1.38         66         1.7           7         0.75         27         1.07         47         1.39         67         1.71           8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75	OUT_SEL <7:0>	V <sub>OUT</sub> (V)	VOUT_SEL <7:0>	V <sub>OUT</sub> (V)	VOUT_SEL <7:0>	V <sub>OUT</sub> (V)	VOUT_SEL <7:0>	V <sub>OUT</sub> (V)			
2         0.7         22         1.02         42         1.34         62         1.66           3         0.71         23         1.03         43         1.35         63         1.67           4         0.72         24         1.04         44         1.36         64         1.68           5         0.73         25         1.05         45         1.37         65         1.69           6         0.74         26         1.06         46         1.38         66         1.7           7         0.75         27         1.07         47         1.39         67         1.71           8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76	0	0.68	20	1	40	1.32	60	1.64			
3         0.71         23         1.03         43         1.35         63         1.67           4         0.72         24         1.04         44         1.36         64         1.68           5         0.73         25         1.05         45         1.37         65         1.69           6         0.74         26         1.06         46         1.38         66         1.7           7         0.75         27         1.07         47         1.39         67         1.71           8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77	1	0.69	21	1.01	41	1.33	61	1.65			
4         0.72         24         1.04         44         1.36         64         1.68           5         0.73         25         1.05         45         1.37         65         1.69           6         0.74         26         1.06         46         1.38         66         1.7           7         0.75         27         1.07         47         1.39         67         1.71           8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78	2	0.7	22	1.02	42	1.34	62	1.66			
5         0.73         25         1.05         45         1.37         65         1.69           6         0.74         26         1.06         46         1.38         66         1.7           7         0.75         27         1.07         47         1.39         67         1.71           8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79	3	0.71	23	1.03	43	1.35	63	1.67			
6 0.74 26 1.06 46 1.38 66 1.7 7 0.75 27 1.07 47 1.39 67 1.71 8 0.76 28 1.08 48 1.4 68 1.72 9 0.77 29 1.09 49 1.41 69 1.73 A 0.78 2A 1.1 4A 1.42 6A 1.74 B 0.79 2B 1.11 4B 1.43 6B 1.75 C 0.8 2C 1.12 4C 1.44 6C 1.76 D 0.81 2D 1.13 4D 1.45 6D 1.77 E 0.82 2E 1.14 4E 1.46 6E 1.78 F 0.83 2F 1.15 4F 1.47 6F 1.79 10 0.84 30 1.16 50 1.48 70 1.8 11 0.85 31 1.17 51 1.49 71 1.81 12 0.86 32 1.18 52 1.5 72 1.82 13 0.87 33 1.19 53 1.51 73 1.83 14 0.88 34 1.2 54 1.52 74 1.84 15 0.89 35 1.21 55 1.55 77 1.87 18 0.92 38 1.24 58 1.56 78 1.88 19 0.93 39 1.25 59 1.57 79 1.88 10 0.94 3A 1.26 5A 1.58 7A 1.9 11B 0.95 3B 1.27 5B 1.59 7B 1.91 11C 0.96 3C 1.28 5C 1.6 7C 1.92 1D 0.97 3D 1.29 5D 1.61 7D 1.93	4	0.72	24	1.04	44	1.36	64	1.68			
7         0.75         27         1.07         47         1.39         67         1.71           8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81	5	0.73	25	1.05	45	1.37	65	1.69			
8         0.76         28         1.08         48         1.4         68         1.72           9         0.77         29         1.09         49         1.41         69         1.73           A         0.78         2A         1.1         4A         1.42         6A         1.74           B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82	6	0.74	26	1.06	46	1.38	66	1.7			
9 0.77 29 1.09 49 1.41 69 1.73  A 0.78 2A 1.1 4A 1.42 6A 1.74  B 0.79 2B 1.11 4B 1.43 6B 1.75  C 0.8 2C 1.12 4C 1.44 6C 1.76  D 0.81 2D 1.13 4D 1.45 6D 1.77  E 0.82 2E 1.14 4E 1.46 6E 1.78  F 0.83 2F 1.15 4F 1.47 6F 1.79  10 0.84 30 1.16 50 1.48 70 1.8  11 0.85 31 1.17 51 1.49 71 1.81  12 0.86 32 1.18 52 1.5 72 1.82  13 0.87 33 1.19 53 1.51 73 1.83  14 0.88 34 1.2 54 1.52 74 1.84  15 0.89 35 1.21 55 1.53 75 1.85  16 0.9 36 1.22 56 1.54 76 1.86  17 0.91 37 1.23 57 1.55 77 1.87  18 0.92 38 1.24 58 1.56 78 1.88  19 0.93 39 1.25 59 1.57 79 1.89  1A 0.94 3A 1.26 5A 1.58 7A 1.9  1D 0.97 3D 1.29 5D 1.61 7D 1.93	7	0.75	27	1.07	47	1.39	67	1.71			
A 0.78 2A 1.1 4A 1.42 6A 1.74  B 0.79 2B 1.11 4B 1.43 6B 1.75  C 0.8 2C 1.12 4C 1.44 6C 1.76  D 0.81 2D 1.13 4D 1.45 6D 1.77  E 0.82 2E 1.14 4E 1.46 6E 1.78  F 0.83 2F 1.15 4F 1.47 6F 1.79  10 0.84 30 1.16 50 1.48 70 1.8  11 0.85 31 1.17 51 1.49 71 1.81  12 0.86 32 1.18 52 1.5 72 1.82  13 0.87 33 1.19 53 1.51 73 1.83  14 0.88 34 1.2 54 1.52 74 1.84  15 0.89 35 1.21 55 1.53 75 1.85  16 0.9 36 1.22 56 1.54 76 1.86  17 0.91 37 1.23 57 1.55 77 1.87  18 0.92 38 1.24 58 1.56 78 1.88  19 0.93 39 1.25 59 1.57 79 1.89  1A 0.94 3A 1.26 5A 1.58 7A 1.9  1D 0.97 3D 1.29 5D 1.61 7D 1.93	8	0.76	28	1.08	48	1.4	68	1.72			
B         0.79         2B         1.11         4B         1.43         6B         1.75           C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82           13         0.87         33         1.19         53         1.51         73         1.83           14         0.88         34         1.2         54         1.52         74         1.84           15         0.89         35         1.21         55         1.53         75         1.85 </td <td>9</td> <td>0.77</td> <td>29</td> <td>1.09</td> <td>49</td> <td>1.41</td> <td>69</td> <td>1.73</td>	9	0.77	29	1.09	49	1.41	69	1.73			
C         0.8         2C         1.12         4C         1.44         6C         1.76           D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82           13         0.87         33         1.19         53         1.51         73         1.83           14         0.88         34         1.2         54         1.52         74         1.84           15         0.89         35         1.21         55         1.53         75         1.85           16         0.9         36         1.22         56         1.54         76         1.86 </td <td>А</td> <td>0.78</td> <td>2A</td> <td>1.1</td> <td>4A</td> <td>1.42</td> <td>6A</td> <td>1.74</td>	А	0.78	2A	1.1	4A	1.42	6A	1.74			
D         0.81         2D         1.13         4D         1.45         6D         1.77           E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82           13         0.87         33         1.19         53         1.51         73         1.83           14         0.88         34         1.2         54         1.52         74         1.84           15         0.89         35         1.21         55         1.53         75         1.85           16         0.9         36         1.22         56         1.54         76         1.86           17         0.91         37         1.23         57         1.55         77         1.87	В	0.79	2B	1.11	4B	1.43	6B	1.75			
E         0.82         2E         1.14         4E         1.46         6E         1.78           F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82           13         0.87         33         1.19         53         1.51         73         1.83           14         0.88         34         1.2         54         1.52         74         1.84           15         0.89         35         1.21         55         1.53         75         1.85           16         0.9         36         1.22         56         1.54         76         1.86           17         0.91         37         1.23         57         1.55         77         1.87           18         0.92         38         1.24         58         1.56         78         1.88	С	0.8	2C	1.12	4C	1.44	6C	1.76			
F         0.83         2F         1.15         4F         1.47         6F         1.79           10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82           13         0.87         33         1.19         53         1.51         73         1.83           14         0.88         34         1.2         54         1.52         74         1.84           15         0.89         35         1.21         55         1.53         75         1.85           16         0.9         36         1.22         56         1.54         76         1.86           17         0.91         37         1.23         57         1.55         77         1.87           18         0.92         38         1.24         58         1.56         78         1.88           19         0.93         39         1.25         59         1.57         79         1.89	D	0.81	2D	1.13	4D	1.45	6D	1.77			
10         0.84         30         1.16         50         1.48         70         1.8           11         0.85         31         1.17         51         1.49         71         1.81           12         0.86         32         1.18         52         1.5         72         1.82           13         0.87         33         1.19         53         1.51         73         1.83           14         0.88         34         1.2         54         1.52         74         1.84           15         0.89         35         1.21         55         1.53         75         1.85           16         0.9         36         1.22         56         1.54         76         1.86           17         0.91         37         1.23         57         1.55         77         1.87           18         0.92         38         1.24         58         1.56         78         1.88           19         0.93         39         1.25         59         1.57         79         1.89           1A         0.94         3A         1.26         5A         1.58         7A         1.9	Е	0.82	2E	1.14	4E	1.46	6E	1.78			
11     0.85     31     1.17     51     1.49     71     1.81       12     0.86     32     1.18     52     1.5     72     1.82       13     0.87     33     1.19     53     1.51     73     1.83       14     0.88     34     1.2     54     1.52     74     1.84       15     0.89     35     1.21     55     1.53     75     1.85       16     0.9     36     1.22     56     1.54     76     1.86       17     0.91     37     1.23     57     1.55     77     1.87       18     0.92     38     1.24     58     1.56     78     1.88       19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	F	0.83	2F	1.15	4F	1.47	6F	1.79			
12     0.86     32     1.18     52     1.5     72     1.82       13     0.87     33     1.19     53     1.51     73     1.83       14     0.88     34     1.2     54     1.52     74     1.84       15     0.89     35     1.21     55     1.53     75     1.85       16     0.9     36     1.22     56     1.54     76     1.86       17     0.91     37     1.23     57     1.55     77     1.87       18     0.92     38     1.24     58     1.56     78     1.88       19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.61     7D     1.93	10	0.84	30	1.16	50	1.48	70	1.8			
13     0.87     33     1.19     53     1.51     73     1.83       14     0.88     34     1.2     54     1.52     74     1.84       15     0.89     35     1.21     55     1.53     75     1.85       16     0.9     36     1.22     56     1.54     76     1.86       17     0.91     37     1.23     57     1.55     77     1.87       18     0.92     38     1.24     58     1.56     78     1.88       19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	11	0.85	31	1.17	51	1.49	71	1.81			
14       0.88       34       1.2       54       1.52       74       1.84         15       0.89       35       1.21       55       1.53       75       1.85         16       0.9       36       1.22       56       1.54       76       1.86         17       0.91       37       1.23       57       1.55       77       1.87         18       0.92       38       1.24       58       1.56       78       1.88         19       0.93       39       1.25       59       1.57       79       1.89         1A       0.94       3A       1.26       5A       1.58       7A       1.9         1B       0.95       3B       1.27       5B       1.59       7B       1.91         1C       0.96       3C       1.28       5C       1.61       7D       1.93	12	0.86	32	1.18	52	1.5	72	1.82			
15     0.89     35     1.21     55     1.53     75     1.85       16     0.9     36     1.22     56     1.54     76     1.86       17     0.91     37     1.23     57     1.55     77     1.87       18     0.92     38     1.24     58     1.56     78     1.88       19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	13	0.87	33	1.19	53	1.51	73	1.83			
16       0.9       36       1.22       56       1.54       76       1.86         17       0.91       37       1.23       57       1.55       77       1.87         18       0.92       38       1.24       58       1.56       78       1.88         19       0.93       39       1.25       59       1.57       79       1.89         1A       0.94       3A       1.26       5A       1.58       7A       1.9         1B       0.95       3B       1.27       5B       1.59       7B       1.91         1C       0.96       3C       1.28       5C       1.6       7C       1.92         1D       0.97       3D       1.29       5D       1.61       7D       1.93	14	0.88	34	1.2	54	1.52	74	1.84			
17     0.91     37     1.23     57     1.55     77     1.87       18     0.92     38     1.24     58     1.56     78     1.88       19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	15	0.89	35	1.21	55	1.53	75	1.85			
18     0.92     38     1.24     58     1.56     78     1.88       19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	16	0.9	36	1.22	56	1.54	76	1.86			
19     0.93     39     1.25     59     1.57     79     1.89       1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	17	0.91	37	1.23	57	1.55	77	1.87			
1A     0.94     3A     1.26     5A     1.58     7A     1.9       1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	18	0.92	38	1.24	58	1.56	78	1.88			
1B     0.95     3B     1.27     5B     1.59     7B     1.91       1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	19	0.93	39	1.25	59	1.57	79	1.89			
1C     0.96     3C     1.28     5C     1.6     7C     1.92       1D     0.97     3D     1.29     5D     1.61     7D     1.93	1A	0.94	3A	1.26	5A	1.58	7A	1.9			
1D 0.97 3D 1.29 5D 1.61 7D 1.93	1B	0.95	3B	1.27	5B	1.59	7B	1.91			
	1C	0.96	3C	1.28	5C	1.6	7C	1.92			
1E 0.98 3E 1.3 5E 1.62 7E 1.94	1D	0.97	3D	1.29	5D	1.61	7D	1.93			
	1E	0.98	3E	1.3	5E	1.62	7E	1.94			

± 0 0 1/4 0 1/4		
表 8-2. Vout Outp	out voitage Sei	iting (continued)

OUT_SEL <7:0>	V <sub>OUT</sub> (V)	VOUT_SEL <7:0>	V <sub>OUT</sub> (V)	VOUT_SEL <7:0>	V <sub>OUT</sub> (V)	VOUT_SEL <7:0>	V <sub>OUT</sub> (V)
1F	0.99	3F	1.31	5F	1.63	7F	1.95

#### 8.3.2 Enable and Adjusting UVLO

The EN1, EN2, and EN3 pin provide electrical on and off control of the device. When the EN1, EN2, EN3 pin voltage exceeds the threshold voltage, the device starts operation. If each ENx pin voltage is pulled below the threshold voltage, the regulator stops switching and enters low Iq state.

The EN pin has an internal pullup current source, allowing the user to float the EN pin for enabling the device. If an application requires controlling the EN pin, use open drain or open collector output logic to interface with the pin.

The device implements internal UVLO circuitry on the VIN pin. The device is disabled when the VIN pin voltage falls below the internal VIN UVLO threshold. The internal VIN UVLO threshold has a hysteresis of 500 mV. If an application requires either a higher UVLO threshold on the VIN pin or a secondary UVLO on the PVINx, in split rail applications, then the ENx pin can be configured as shown in 图 8-3, 图 8-4, and 图 8-5. When using the external UVLO function TI recommends to set the hysteresis to be greater than 500 mV.

The EN pin has a small pullup current Ip which sets the default state of the pin to enable when no external components are connected. The pullup current is also used to control the voltage hysteresis for the UVLO function because it increases by Ih after the EN pin crosses the enable threshold. The UVLO thresholds can be calculated using 方程式 2 and 方程式 3.

$$R_{1} = \frac{V_{START} \left( \frac{V_{ENFALLING}}{V_{ENRISING}} \right) - V_{STOP}}{I_{P} \left( 1 - \frac{V_{ENFALLING}}{V_{ENRISING}} \right) + I_{h}}$$
(2)

$$R_{2} = \frac{R_{1} \times V_{ENFALLING}}{V_{STOP} - V_{ENFALLING} + R_{1} (I_{h} + I_{p})}$$
(3)

#### where

- I<sub>h</sub> = 3 μA I<sub>p</sub> = 3.8 μA
- V<sub>ENRISING</sub> = 1.2 V
- V<sub>ENFALLING</sub> = 1.15 V

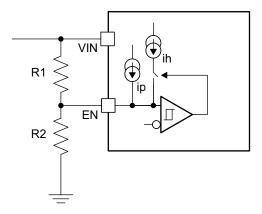


图 8-3. Adjustable VIN UVLO

Product Folder Links: TPS65263

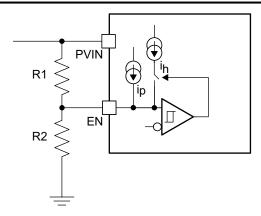


图 8-4. Adjustable PVIN UVLO, VIN > 4.5 V

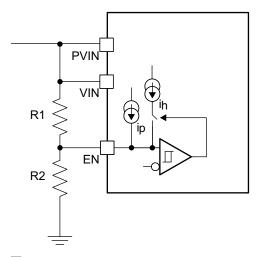


图 8-5. Adjustable VIN and PVIN UVLO

#### 8.3.3 Soft-Start Time

The voltage on the respective SS pin controls the start-up of buck output. When the voltage on the SS pin is less than the internal 0.6-V reference, The TPS65263 regulates the internal feedback voltage to the voltage on the SS pin instead of 0.6 V. The SS pin can be used to program an external soft-start function or to allow output of buck to track another supply during start-up. The device has an internal pullup current source of 5  $\mu$ A (typical) that charges an external soft-start capacitor to provide a linear ramping voltage at SS pin. The TPS65263 regulates the internal feedback voltage to the voltage on the SS pin, allowing VOUT to rise smoothly from 0V to its regulated voltage without inrush current. The soft-start time can be calculated approximately by  $\dot{\pi}$ 

$$Tss(ms) = \frac{Css(nF) \times Vref(V)}{Iss(\mu A)}$$
(4)

Many of the common power supply sequencing methods can be implemented using the SSx and ENx pins. 图 8-6 shows the method implementing ratiometric sequencing by connecting the SSx pins of three buck channels together. The regulator outputs ramp up and reach regulation at the same time. When calculating the soft-start time, the pullup current source must be tripled in 方程式 4.

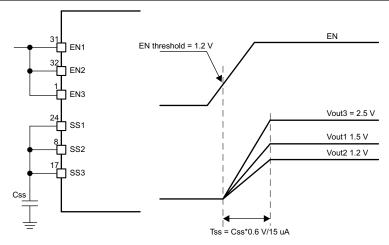


图 8-6. Ratiometric Power-Up Using SSx Pins

Simultaneous power supply sequencing can be implemented by connecting capacitor to SSx pin, shown in 图 8-7. Using 方程式 4 and 方程式 5, the capacitors can be calculated.

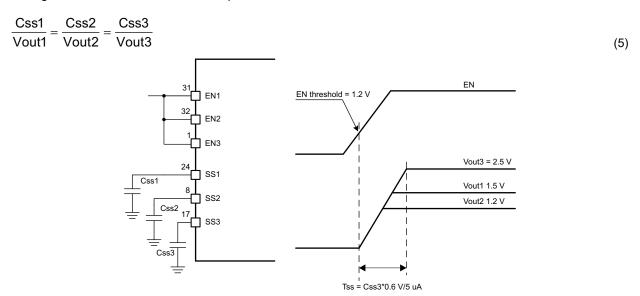


图 8-7. Simultaneous Startup Sequence Using SSx Pins

### 8.3.4 Power-Up Sequencing

The TPS65263 has dedicated enable pin and soft-start pin for each converter. The converter enable pins are biased by a current source that allows for easy sequencing by the addition of an external capacitor. Disabling the converter with an active pull-down transistor on the ENs pin allows for a predictable power-down timing operation. 

8 8-8 shows the timing diagram of a typical buck power-up sequence with connecting a capacitor at ENx pin.

A typical 1.4- $\mu$ A current is charging ENx pin from input supply. When ENx pin voltage rise to typical 0.4 V, the internal V7V LDO turns on. A 3.8- $\mu$ A pullup current is sourcing ENx. After ENx pin voltage reaches to ENx enabling threshold, 3- $\mu$ A hysteresis current sources to the pin to improve noise sensitivity. The internal soft-start comparator compares SS pin voltage to 1.2 V. When SS pin voltage ramps up to 1.2 V, PGOOD monitor is enabled. After PGOOD deglitch time, PGOOD is deasserted. SS pin voltage eventually is clamped around 2.1 V.



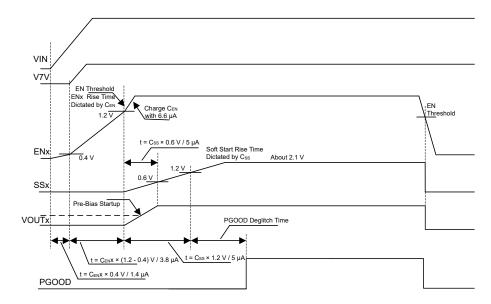


图 8-8. Startup Power Sequence

#### 8.3.5 V7V Low Dropout Regulator and Bootstrap

Power for the high-side and low-side MOSFET drivers and most other internal circuitry is derived from the V7V pin. The internal built-in low dropout linear regulator (LDO) supplies 6.3 V (typical) from VIN to V7V. A 10- $\mu$ F ceramic capacitor must be connected from V7V pin to power ground.

If the input voltage, VIN decreases to UVLO threshold voltage, the UVLO comparator detects V7V pin voltage and forces the converter off.

Each high-side MOSFET driver is biased from the floating bootstrap capacitor CB, shown in 🛭 8-9, which is normally recharged during each cycle through an internal low-side MOSFET or the body diode of low-side MOSFET when the high-side MOSFET turns off. The boot capacitor is charged when the BST pin voltage is less than VIN and BST-LX voltage is below regulation. The recommended value of this ceramic capacitor is 47 nF. TI recommends a ceramic capacitor with an X7R or X5R grade dielectric with a voltage rating of 10 V or higher because of the stable characteristics over temperature and voltage. Each low-side MOSFET driver is powered from V7V pin directly.

To improve drop out, the device is designed to operate at 100% duty cycle as long as the BST to LX pin voltage is greater than the BST-LX UVLO threshold, which is typically 2.1 V. When the voltage between BST and LX drops below the BST-LX UVLO threshold, the high-side MOSFET is turned off and the low-side MOSFET is turned on allowing the boot capacitor to be recharged.

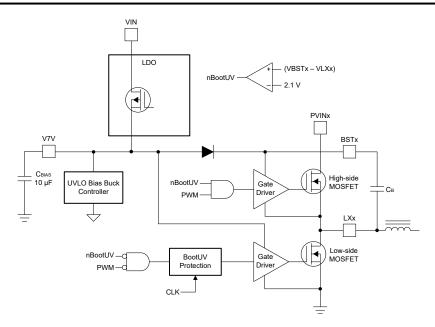


图 8-9. V7V Linear Dropout Regulator and Bootstrap Voltage Diagram

#### 8.3.6 Out-of-Phase Operation

To reduce input ripple current, the switch clock of buck1 is 180° out-of-phase from the clock of buck2 and buck3. This enables the system having less input current ripple to reduce input capacitors' size, cost, and EMI.

#### 8.3.7 Output Overvoltage Protection (OVP)

The device incorporates an output OVP circuit to minimize output voltage overshoot. When the output is overloaded, the error amplifier compares the actual output voltage to the internal reference voltage. If the FB pin voltage is lower than the internal reference voltage for a considerable time, the output of the error amplifier demands maximum output current. After the condition is removed, the regulator output rises and the error amplifier output transitions to the steady state voltage. In some applications with small output capacitance, the load can respond faster than the error amplifier. This leads to the possibility of an output overshoot. Each buck compares the FB pin voltage to the OVP threshold. If the FB pin voltage is greater than the OVP threshold, the high-side MOSFET is turned off preventing current from flowing to the output and minimizing output overshoot. When the FB voltage drops lower than the OVP threshold, the high-side MOSFET turns on at the next clock cycle.

#### 8.3.8 Pulse Skipping Mode (PSM)

The TPS65263 can enter high-efficiency PSM operation at light load current. To disable PSM operation, set  $VOUTx\_COM$  registers' bit 1 to 1 through  $I^2C$  interface.

When a controller is enabled for PSM operation, the peak inductor current is sensed and compared with 230-mA current typically. Because the integrated current comparator catches the peak inductor current only, the average load current entering PSM varies with the applications and external output filters. In PSM, the sensed peak inductor current is clamped at 230 mA, shown in ₹8-10.

When a controller operates in PSM, the inductor current is not allowed to reverse. The reverse current comparator turns off the low-side MOSFET when the inductor current reaches zero, preventing it from reversing and going negative.

Due to the delay in the circuit and current comparator tdly (typical 50 nS at Vin = 12 V), the real peak inductor current threshold to turn off high-side power MOSFET can shift higher depending on inductor inductance and input/output voltages. The threshold of peak inductor current to turn off high-side power MOSFET can be calculated by 方程式 6.



$$IL_{PEAK} = 230mA + \frac{vin - vout}{L} \times tdly$$
(6)

When the charge accumulated on Vout capacitor is more than loading need, COMP pin voltage drops to low voltage driven by error amplifier. There is an internal comparator at COMP pin. If comp voltage is lower than 0.35 V, power stage stops switching to save power.

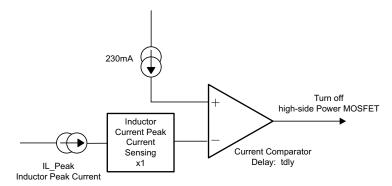


图 8-10. PSM Current Comparator

#### 8.3.9 Slope Compensation

To prevent the sub-harmonic oscillations when the device operates at duty cycles greater than 50%, the TPS65263 adds built-in slope compensation, which is a compensating ramp to the switch current signal.

#### 8.3.10 Overcurrent Protection

The device is protected from overcurrent conditions by cycle-by-cycle current limiting on both the high-side MOSFET and the low-side MOSFET.

#### 8.3.10.1 High-Side MOSFET Overcurrent Protection

The device implements current mode control which uses the COMP pin voltage to control the turn off of the high-side MOSFET and the turn on of the low-side MOSFET on a cycle by cycle basis. Each cycle the switch current and the current reference generated by the COMP pin voltage are compared, when the peak switch current intersects the current reference, the high-side switch is turned off.

#### 8.3.10.2 Low-Side MOSFET Overcurrent Protection

While the low-side MOSFET is turned on, its conduction current is monitored by the internal circuitry. During normal operation the low-side MOSFET sources current to the load. At the end of every clock cycle, the low-side MOSFET sourcing current is compared to the internally set low-side sourcing current limit. If the low-side sourcing current is exceeded, the high-side MOSFET is not turned on and the low-side MOSFET stays on for the next cycle. The high-side MOSFET is turned on again when the low-side current is below the low-side sourcing current limit at the start of a cycle.

The low-side MOSFET can also sink current from the load. If the low-side sinking current limit is exceeded, the low-side MOSFET is turned off immediately for the rest of that clock cycle. In this scenario both MOSFETs are off until the start of the next cycle.

Furthermore, if an output overload condition (as measured by the COMP pin voltage) has lasted for more than the hiccup wait time which is programmed for 0.5 ms (typical) shown in 8 8-11, the device will shut down itself and restart after the hiccup time of 14 ms (typical). The hiccup mode helps to reduce the device power dissipation under severe overcurrent condition.

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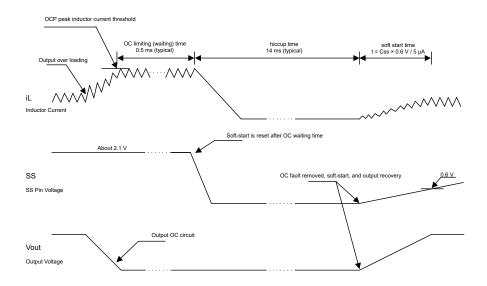


图 8-11. Overcurrent Protection

#### 8.3.11 Power Good

The power good indicator for each buck channel can be read back through I<sup>2</sup> C.

When feedback voltage of the buck is between 95% (rising) and 105% (falling) of the internal voltage reference, the bit0, bit1 and bit2 in SYS\_STATUS (address 0x06H) present the feedback voltage in regulation (logic 1) for buck1, buck2 and buck3 respectively. When feedback voltage of the buck is lower than 92.5% (falling) or greater than 107.5% (rising) of the nominal internal reference voltage, the bit0, bit1 and bit2 in SYS\_STATUS (address 0x06H) present the feedback voltage beyond regulation (logic 0) for buck1, buck2 and buck3 respectively.

#### 8.3.12 Thermal Shutdown

The internal thermal shutdown circuitry forces the device to stop switching if the junction temperature exceeds 160°C typically. The device reinitiates the power up sequence when the junction temperature drops below 140°C typically.

#### 8.4 Device Functional Modes

#### 8.4.1 Serial Interface Description

I<sup>2</sup>C is a 2-wire serial interface developed by NXP<sup>™</sup> Semiconductors (see I<sup>2</sup>C-Bus Specification, Version 2.1, January 2000). The bus consists of a data line (SDA) and a clock line (SCL) with pullup structures. When the bus is idle, both SDA and SCL lines are pulled high. All the I<sup>2</sup>C-compatible devices connect to the I<sup>2</sup>C bus through open drain I/O pins, SDA and SCL. A controller device, usually a microcontroller or a digital signal processor, controls the bus. The controller is responsible for generating the SCL signal and device addresses. The controller also generates specific conditions that indicate the START and STOP of data transfer. A target device receives and/or transmits data on the bus under control of the controller device.

The TPS65263 device works as a target and supports the following data transfer modes, as defined in the  $I^2$ C-Bus Specification: standard mode (100 kbps), and fast mode (400 kbps). The interface adds flexibility to the power supply solution, enabling most functions to be programmed to new values depending on the instantaneous application requirements. Register contents remain intact as long as supply voltage remains above 4.25 V (typical).

The data transfer protocol for standard and fast modes is exactly the same, therefore, they are referred to as F/S-mode in this document. The TPS65263 device supports 7-bit addressing. Ten-bit addressing and general call address are not supported.

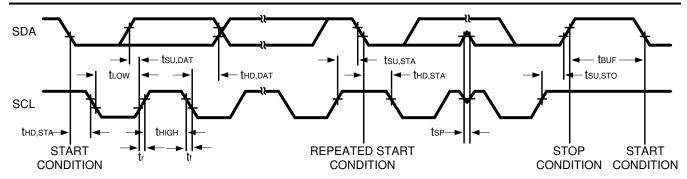


图 8-12. I<sup>2</sup>C Interface Timing Diagram

### 8.4.2 I<sup>2</sup>C Update Sequence

The TPS65263 requires a start condition, a valid  $I^2C$  address, a register address byte, and a data byte for a single update. After the receipt of each byte, TPS65263 device acknowledges by pulling the SDA line low during the high period of a single clock pulse. A valid  $I^2C$  address selects the TPS65263. TPS65263 performs an update on the falling edge of the LSB byte.

When the TPS65263 is in hardware shutdown (EN1, EN2, and EN3 pin tied to ground) the device cannot be updated through the  $I^2C$  interface. Conversely, the  $I^2C$  interface is fully functional during software shutdown (EN1, EN2, and EN3 bit = 0).

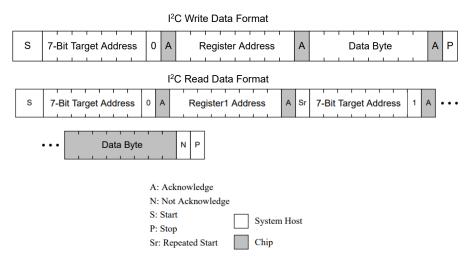


图 8-13. I<sup>2</sup>C Write and Read Data Format

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# 8.5 Register Maps

# 8.5.1 Register Description

Register descriptions are shown in the following tables.

表 8-3. Register Addresses

24		
NAME	BITS	ADDRESS
VOUT1_SEL	8	0x00H
VOUT2_SEL	8	0x01H
VOUT3_SEL	8	0x02H
VOUT1_COM	8	0x03H
VOUT2_COM	8	0x04H
VOUT3_COM	8	0x05H
SYS_STATUS	8	0x06H

# 8.5.2 VOUT1\_SEL: Vout1 Voltage Selection Register (offset = 0x00H)

## 图 8-14. VOUT1\_SEL

7	6	5	4	3	2	1	0	
Vout1_Bit7	Vout1_Bit6	Vout1_Bit5	Vout1_Bit4	Vout1_Bit3	Vout1_Bit2	Vout1_Bit1	Vout1_Bit0	
R/W								

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 表 8-4. VOUT1\_SEL Field Descriptions

		200		· · · · · · · · · · · · · · · · · ·
Bit	Field	Туре	Reset	Description
7	Vout1_Bit7	R/W		GO bit, must set to 1 to enable I <sup>2</sup> C controlled VID voltages (default 0)
6	Vout1_Bit6			
5	Vout1_Bit5			128 voltage selections with 7-bits control (default 0)
4	Vout1_Bit4	]		Voltage range: 0.68 to 1.95 V
3	Vout1_Bit3	R/W		Voltage step resolution: 10 mV
2	Vout1_Bit2			0x00H: Vout1 = 0.68 V;
1	Vout1_Bit1			0x7FH: Vout1 = 1.95 V
0	Vout1_Bit0	1		
	_			



# 8.5.3 VOUT2\_SEL: Vout2 Voltage Selection Register (offset = 0x01H)

# 图 8-15. VOUT2\_SEL

7	6	5	4	3	2	1	0
Vout2_Bit7	Vout2_Bit6	Vout2_Bit5	Vout2_Bit4	Vout2_Bit3	Vout2_Bit2	Vout2_Bit1	Vout2_Bit0
			R/	W			

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 表 8-5. VOUT2\_SEL Field Descriptions

Bit	Field	Туре	Reset	Description
7	Vout2_Bit7	R/W		GO bit, must set to 1 to enable I <sup>2</sup> C controlled VID voltages (default 0)
6	Vout2_Bit6			
5	Vout2_Bit5			128 voltage selections with 7-bits control (default 0)
4	Vout2_Bit4			Voltage range: 0.68 to 1.95 V
3	Vout2_Bit3	R/W		Voltage step resolution: 10 mV
2	Vout2_Bit2			0x00H: Vout2 = 0.68 V;
1	Vout2_Bit1			0x7FH: Vout2 = 1.95 V
0	Vout2_Bit0			

# 8.5.4 VOUT3\_SEL: Vout3 Voltage Selection Register (offset = 0x02H)

## 图 8-16. VOUT3\_SEL

7	6	5	4	3	2	1	0
Vout3_Bit7	Vout3_Bit6	Vout3_Bit5	Vout3_Bit4	Vout3_Bit3	Vout3_Bit2	Vout3_Bit1	Vout3_Bit0
			R/	W			

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 表 8-6. VOUT3\_SEL Field Descriptions

Bit	Field	Туре	Reset	Description
7	Vout3_Bit7	R/W		GO bit, must set to 1 to enable I <sup>2</sup> C controlled VID voltages (default 0)
6	Vout3_Bit6			
5	Vout3_Bit5			128 voltage selections with 7-bits control (default 0)
4	Vout3_Bit4			Voltage range: 0.68 to 1.95 V
3	Vout3_Bit3	R/W		Voltage step resolution: 10 mV
2	Vout3_Bit2			0x00H: Vout3 = 0.68 V;
1	Vout3_Bit1			0x7FH: Vout3 = 1.95 V
0	Vout3_Bit0			

Product Folder Links: TPS65263

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# 8.5.5 VOUT1\_COM: Buck1 Command Register (offset = 0x03H)

# 图 8-17. VOUT1\_COM

7	6	5	4	3	2	1	0
N/A	SR3	SR2	SR1	N/A	N/A	Mode1	nEN1
			R	W			

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 表 8-7. VOUT1\_COM Field Descriptions

Bit	Field	Туре	Reset	Description		
7	N/A	R/W		Not used (default 0)		
6	SR3	R/W		Vout1 VID voltage transition slew rate control (default 0)		
5	SR2	R/W		000: 10 mV/cycle; 001: 10 mV/2 cycles;		
4	SR1	R/W		010: 10 mV/4 cycles; 011: 10 mV/8 cycles; 100: 10 mV/16 cycles; 101: 10 mV/32 cycles; 110: 10 mV/64 cycles; 111: 10 mV/128 cycles		
3	N/A	R/W		Not used (default 0)		
2	N/A	R/W		Not used (default 0)		
1	Mode1	R/W		Enable buck1 PSM operation at light load (default);     Forced buck1 PWM mode operation		
0	nEN1	R/W		0: Enable buck1 (default); 1: Disable buck1		

# 8.5.6 VOUT2\_COM: Buck2 Command Register (offset = 0x04H)

## 图 8-18. VOUT2 COM

				_				
7	6	5	4	3	2	1	0	
N/A	SR3	SR2	SR1	N/A	N/A	Mode2	nEN2	
R/W								

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# 表 8-8. VOUT2\_COM Field Descriptions

Bit	Field	Туре	Reset	Description		
7	N/A	R/W		Not used (default 0)		
6	SR3	R/W		Vout2 VID voltage transition slew rate control (default 0)		
5	SR2	R/W		000: 10 mV/cycle; 001: 10 mV/2 cycles;		
4	SR1	R/W		010: 10 mV/4 cycles; 011: 10 mV/8 cycles; 100: 10 mV/16 cycles; 101: 10 mV/32 cycles; 110: 10 mV/64 cycles; 111: 10 mV/128 cycles		
3	N/A	R/W		Not used (default 0)		
2	N/A	R/W		Not used (default 0)		
1	Mode2	R/W		Enable buck2 PSM operation at light load (default);     Forced buck2 PWM mode operation		
0	nEN2	R/W		0: Enable buck2 (default); 1: Disable buck2		

Product Folder Links: TPS65263



# 8.5.7 VOUT3\_COM: Buck3 Command Register (offset = 0x05H)

# 图 8-19. VOUT3\_COM

7	6	5	4	3	2	1	0	
N/A	SR3	SR2	SR1	N/A	N/A	Mode3	nEN3	
R/W								

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 表 8-9. VOUT3\_COM Field Descriptions

Bit	Field	Туре	Reset	Description
7	N/A	R/W		Not used (default 0)
6	SR3	R/W		Vout3 VID voltage transition slew rate control.
5	SR2	R/W		000: 10 mV/cycle; 001: 10 mV/2 cycles;
4	SR1	R/W		010: 10 mV/4 cycles; 011: 10 mV/8 cycles; 100: 10 mV/16 cycles; 101: 10 mV/32 cycles; 110: 10 mV/64 cycles; 111: 10 mV/128 cycles
3	N/A	R/W		Not used (default 0)
2	N/A	R/W		Not used (default 0)
1	Mode3	R/W		Enable buck3 PSM operation at light load (default);     Forced buck3 PWM mode operation
0	nEN3	R/W		0: Enable buck3 (default); 1: Disable buck3

# 8.5.8 SYS\_STATUS: System Status Register (offset = 0x06H)

## 图 8-20. SYS STATUS

7	6	5	4	3	2	1	0	
OTP	OC3	OC2	OC1	OTW	PGOOD3	PGOOD2	PGOOD1	
R								

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# 表 8-10. SYS\_STATUS Field Descriptions

Bit	Field	Туре	Reset	Description
7	ОТР	R		Die overtemperature protection is not triggered (default);     Die temperature over 160°C, which triggers overtemperature protection.
6	ОС3	R		Buck3 current not beyond the current limit (default);     Buck3 overcurrent limiting and hiccup protection is triggered.
5	OC2	R		Buck2 current not beyond the current limit (default);     Buck2 overcurrent limiting and hiccup protection is triggered.
4	OC1	R		Buck1 current not beyond the current limit (default);     Buck1 overcurrent limiting and hiccup protection is triggered.
3	OTW	R		0: Die temperature below 125°C (default); 1: Die temperature over 125°C.
2	PGOOD3	R		0: Vout3 not in power good monitor's range (default); 1: Vout3 in power good monitor's range.
1	PGOOD2	R		0: Vout2 not in power good monitor's range (default); 1: Vout2 in power good monitor's range.
0	PGOOD1	R		0: Vout1 not in power good monitor's range (default); 1: Vout1 in power good monitor's range.

Product Folder Links: TPS65263

## 9 Application and Implementation

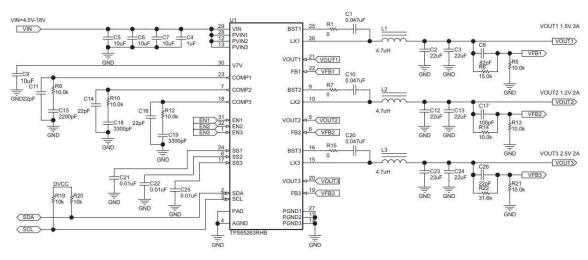
#### 备注

以下应用部分中的信息不属于 TI 器件规格的范围,TI 不担保其准确性和完整性。TI 的客 户应负责确定器件是否适用于其应用。客户应验证并测试其设计,以确保系统功能。

### 9.1 Application Information

The device is triple synchronous step down dc/dc converter with  $I^2C$  interface. It is typically used to convert a higher dc voltage to lower dc voltages with continuous available output current of 3 A / 2 A / 2 A. The following design procedure can be used to select component values for the TPS65263. This section presents a simplified discussion of the design process.

## 9.2 Typical Application



#### 9.2.1 Design Requirements

This example details the design of triple synchronous step-down converter. A few parameters must be known to start the design process. These parameters are typically determined at the system level. For this example, start with the following known parameters:

表 9-1. Design Parameters

PARAMETER	VALUE
Vout1	1.5 V
lout1	3 A
Vout2	1.2 V
lout2	2 A
Vout3	2.5 V
lout3	2 A
Transient response 1-A load step	±5%
Input voltage	12 V normal, 4.5 to 18 V
Output voltage ripple	±1%
Switching frequency	600 kHz

#### 9.2.2 Detailed Design Procedure

#### 9.2.2.1 Output Inductor Selection

To calculate the value of the output inductor, use 方程式 7. LIR is a coefficient that represents the amount of inductor ripple current relative to the maximum output current. The inductor ripple current is filtered by the output capacitor. Therefore, choosing high inductor ripple currents impact the selection of the output capacitor because the output capacitor must have a ripple current rating equal to or greater than the inductor ripple current. In general, the inductor ripple value is at the discretion of the designer; however, LIR is normally from 0.1 to 0.3 for the majority of applications.

$$L = \frac{V_{\text{inmax}} - V_{\text{out}}}{I_{\text{o}} \times \text{LIR}} \times \frac{V_{\text{out}}}{V_{\text{inmax}} \times f_{\text{sw}}}$$
(7)

For the output filter inductor, it is important that the RMS current and saturation current ratings not be exceeded. The RMS and peak inductor current can be found from 方程式 9 and 方程式 10.

$$I_{ripple} = \frac{V_{inmax} - V_{out}}{L} \times \frac{V_{out}}{V_{inmax} \times f_{sw}}$$
(8)

$$I_{Lrms} = \sqrt{I_{O}^{2} + \frac{\left(\frac{V_{out} \times (V_{inmax} - V_{out})}{V_{inmax} \times L \times f_{sw}}\right)^{2}}{12}}$$
(9)

$$I_{Lpeak} = I_{out} + \frac{I_{ripple}}{2}$$
 (10)

The current flowing through the inductor is the inductor ripple current plus the output current. During power up, faults or transient load conditions, the inductor current can increase above the calculated peak inductor current level calculated above. In transient conditions, the inductor current can increase up to the switch current limit of the device. For this reason, the most conservative approach is to specify an inductor with a saturation current rating equal to or greater than the switch current limit rather than the peak inductor current.

#### 9.2.2.2 Output Capacitor Selection

There are three primary considerations for selecting the value of the output capacitor. The output capacitor determines the modulator pole, the output voltage ripple, and how the regulator responds to a large change in load current. The output capacitance needs to be selected based on the most stringent of these three criteria.

The desired response to a large change in the load current is the first criteria. The output capacitor needs to supply the load with current when the regulator cannot. This situation can occur if there are desired hold-up times for the regulator where the output capacitor must hold the output voltage above a certain level for a specified amount of time after the input power is removed. The regulator is also temporarily not able to supply sufficient output current if there is a large, fast increase in the current needs of the load such as a transition from no load to full load. The regulator usually needs two or more clock cycles for the control loop to see the change in load current and output voltage and adjust the duty cycle to react to the change. The output capacitor must be sized to supply the extra current to the load until the control loop responds to the load change. The output capacitance must be large enough to supply the difference in current for 2 clock cycles while only allowing a tolerable amount of droop in the output voltage. 方程式 11 shows the minimum output capacitance necessary to accomplish this.

$$C_{o} = \frac{2 \times \Delta I_{out}}{f_{sw} \times \Delta V_{out}}$$
(11)

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Where  $\Delta$ lout is the change in output current,  $f_{SW}$  is the regulators switching frequency and  $\Delta V_{out}$  is the allowable change in the output voltage.

方程式 12 calculates the minimum output capacitance needed to meet the output voltage ripple specification. Where  $f_{SW}$  is the switching frequency,  $V_{ripple}$  is the maximum allowable output voltage ripple, and  $I_{ripple}$  is the inductor ripple current.

$$C_{o} > \frac{1}{8 \times f_{sw}} \times \frac{1}{\frac{V_{oripple}}{I_{oripple}}}$$
(12)

方程式 13 calculates the maximum ESR an output capacitor can have to meet the output voltage ripple specification.

$$R_{esr} < \frac{V_{oripple}}{I_{oripple}}$$
 (13)

Additional capacitance de-ratings for aging, temperature and DC bias must be factored in which increases this minimum value. Capacitors generally have limits to the amount of ripple current they can handle without failing or producing excess heat. An output capacitor that can support the inductor ripple current must be specified. Some capacitor data sheets specify the root mean square (RMS) value of the maximum ripple current. 方程式 14 can be used to calculate the RMS ripple current the output capacitor needs to support.

$$I_{corms} = \frac{V_{out} \times (V_{inmax} - V_{out})}{\sqrt{12} \times V_{inmax} \times L \times f_{sw}}$$
(14)

### 9.2.2.3 Input Capacitor Selection

The TPS65263 requires a high quality ceramic, type X5R or X7R, input decoupling capacitor of at least 10  $\mu$ F of effective capacitance on the PVIN input voltage pins. In some applications additional bulk capacitance can also be required for the PVIN input. The effective capacitance includes any DC bias effects. The voltage rating of the input capacitor must be greater than the maximum input voltage. The capacitor must also have a ripple current rating greater than the maximum input current ripple of The TPS65263. The input ripple current can be calculated using 方程式 15.

$$I_{inrms} = I_{out} \times \sqrt{\frac{V_{out}}{V_{inmin}} \times \frac{(V_{inmin} - V_{out})}{V_{inmin}}}$$
(15)

The value of a ceramic capacitor varies significantly over temperature and the amount of DC bias applied to the capacitor. The capacitance variations due to temperature can be minimized by selecting a dielectric material that is stable over temperature. X5R and X7R ceramic dielectrics are usually selected for power regulator capacitors because they have a high capacitance to volume ratio and are fairly stable over temperature. The output capacitor must also be selected with the DC bias taken into account. The capacitance value of a capacitor decreases as the DC bias across a capacitor increases. The input capacitance value determines the input ripple voltage of the regulator. The input voltage ripple can be calculated using 方程式 16.

$$\Delta V_{\text{in}} = \frac{I_{\text{outmax}} \times 0.25}{C_{\text{in}} \times f_{\text{sw}}}$$
(16)

#### 9.2.2.4 Loop Compensation

The TPS65263 incorporates a peak current mode control scheme. The error amplifier is a trans-conductance amplifier with a gain of 300 µS. A typical type II compensation circuit adequately delivers a phase margin

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between  $60^{\circ}$  and  $90^{\circ}$ .  $C_b$  adds a high frequency pole to attenuate high frequency noise when needed. To calculate the external compensation components, follow the following steps.

- 1. Select switching frequency  $f_{SW}$  that is appropriate for application depending on L and C sizes, output ripple, EMI, and etc. Switching frequency between 500 kHz to 1 MHz gives best trade-off between performance and cost. To optimize efficiency, lower switching frequency is desired.
- 2. Set up cross over frequency,  $f_c$ , which is typically between 1/5 and 1/20 of  $f_{SW}$ .
- 3. R<sub>C</sub> can be determined by

$$R_{C} = \frac{2\pi \times fc \times Vo \times Co}{G_{m-EA} \times Vref \times G_{m-PS}}$$
(17)

4. Calculate CC by placing a compensation zero at or before the dominant pole  $fp = \frac{1}{C_o \times R_L \times 2\pi}$ 

$$C_{C} = \frac{R_{L} \times Co}{R_{C}}$$
(18)

5. Optional C<sub>b</sub> can be used to cancel the zero from the ESR associated with C<sub>O</sub>.

$$C_{b} = \frac{R_{ESR} \times Co}{R_{C}}$$
(19)

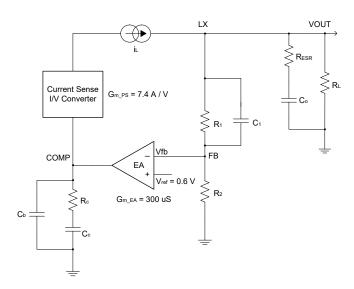
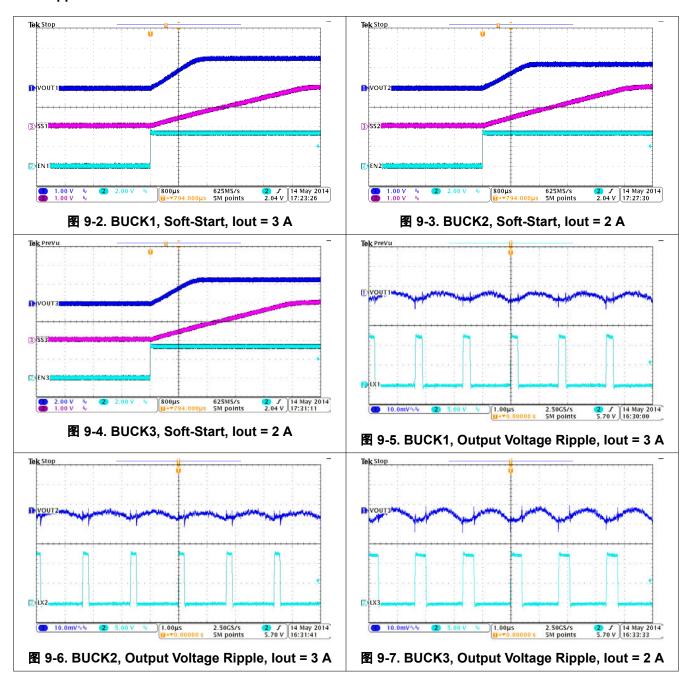


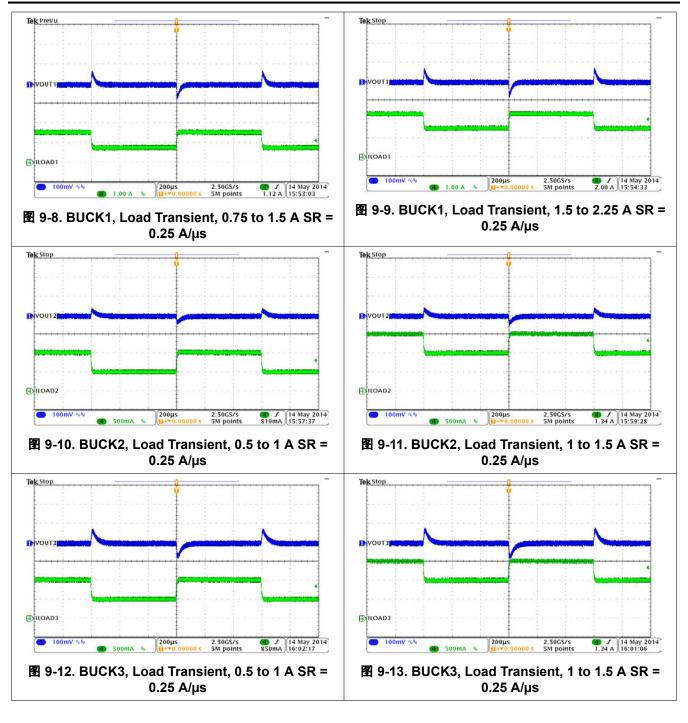
图 9-1. DC/DC Loop Compensation

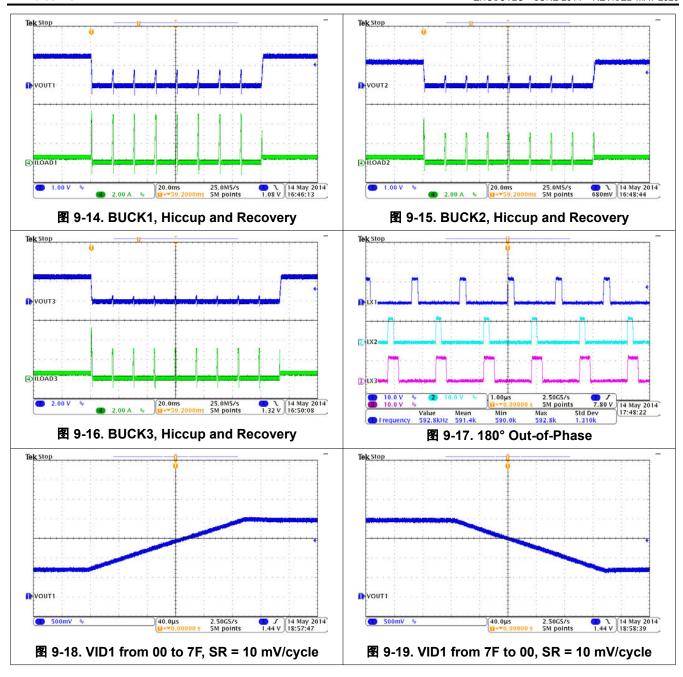


#### 9.2.3 Application Curves

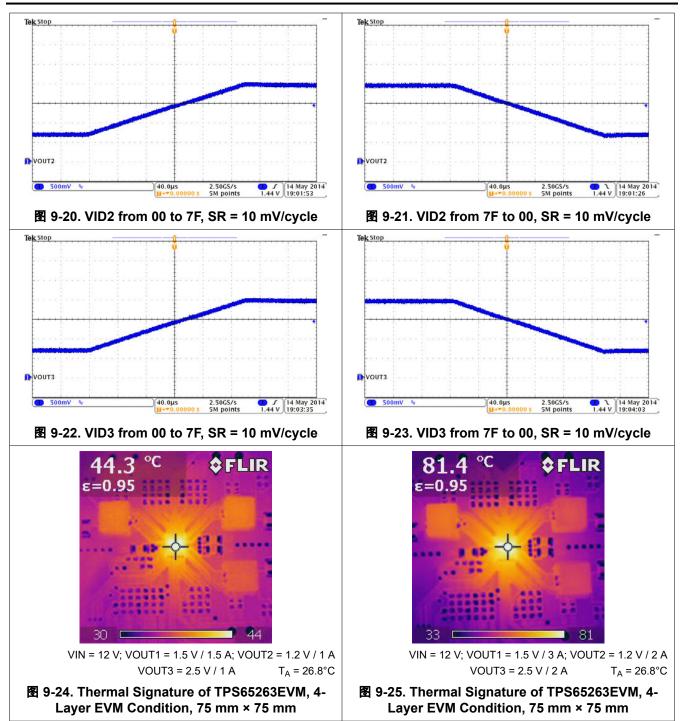












#### 9.3 Power Supply Recommendations

The devices are designed to operate from an input voltage supply range between 4.5 to 18 V. This input power supply must be well regulated. If the input supply is located more than a few inches from the TPS65263 converter additional bulk capacitance can be required in addition to the ceramic bypass capacitors. An electrolytic capacitor with a value of  $47 \, \mu F$  is a typical choice.



# 9.4 Layout

### 9.4.1 Layout Guidelines

The TPS65263 can be layout on 2-layer PCB, shown in 

■ 9-26.

Layout is a critical portion of good power supply design. See **2** 9-26 for a PCB layout example. The top contains the main power traces for PVIN, VOUT, and LX. Also on the top layer are connections for the remaining pins of the TPS65263 and a large top side area filled with ground. The top layer ground area must be connected to the bottom layer ground using vias at the input bypass capacitor, the output filter capacitor and directly under the TPS65263 device to provide a thermal path from the exposed thermal pad land to ground. The bottom layer acts as ground plane connecting analog ground and power ground.

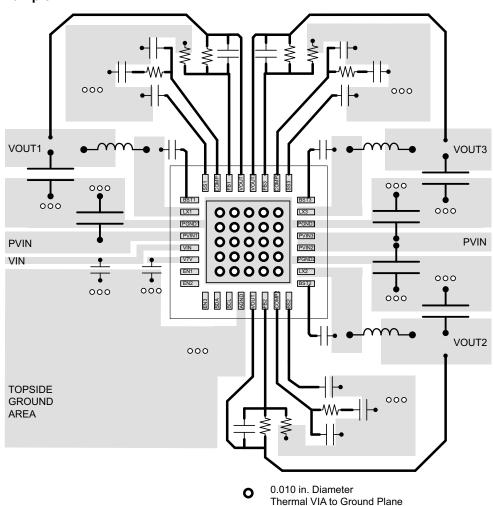
For operation at full rated load, the top side ground area together with the bottom side ground plane must provide adequate heat dissipating area. There are several signals paths that conduct fast changing currents or voltages that can interact with stray inductance or parasitic capacitance to generate noise or degrade the power supplies performance. To help eliminate these problems, the PVIN pin must be bypassed to ground with a low ESR ceramic bypass capacitor with X5R or X7R dielectric. Care must be taken to minimize the loop area formed by the bypass capacitor connections, the PVIN pins, and the ground connections. The VIN pin must also be bypassed to ground using a low ESR ceramic capacitor with X5R or X7R dielectric.

Because the LX connection is the switching node, the output inductor must be located close to the LX pins, and the area of the PCB conductor minimized to prevent excessive capacitive coupling. The output filter capacitor ground must use the same power ground trace as the PVIN input bypass capacitor. Try to minimize this conductor length while maintaining adequate width. The small signal components must be grounded to the analog ground path.

The FB and COMP pins are sensitive to noise so the resistors and capacitors must be located as close as possible to the IC and routed with minimal lengths of trace. The additional external components can be placed approximately as shown.



# 9.4.2 Layout Example



VIA to Ground Plane

图 9-26. PCB Layout

# 10 Device and Documentation Support

# 10.1 接收文档更新通知

要接收文档更新通知,请导航至 ti.com 上的器件产品文件夹。点击*订阅更新* 进行注册,即可每周接收产品信息更 改摘要。有关更改的详细信息,请查看任何已修订文档中包含的修订历史记录。

## 10.2 支持资源

TI E2E™ 支持论坛是工程师的重要参考资料,可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者"按原样"提供。这些内容并不构成 TI 技术规范,并且不一定反映 TI 的观点;请参阅 TI 的《使用条款》。

## 10.3 Trademarks

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# 10.4 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理 和安装程序,可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级,大至整个器件故障。精密的集成电路可能更容易受到损坏,这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

## 10.5 术语表

TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

# 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPS65263RHBR	ACTIVE	VQFN	RHB	32	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TPS 65263	Samples
TPS65263RHBT	ACTIVE	VQFN	RHB	32	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		TPS 65263	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# **PACKAGE OPTION ADDENDUM**

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#### OTHER QUALIFIED VERSIONS OF TPS65263:

Automotive: TPS65263-Q1

NOTE: Qualified Version Definitions:

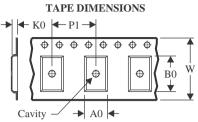
• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

# **PACKAGE MATERIALS INFORMATION**

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# TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	_	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS65263RHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
TPS65263RHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2

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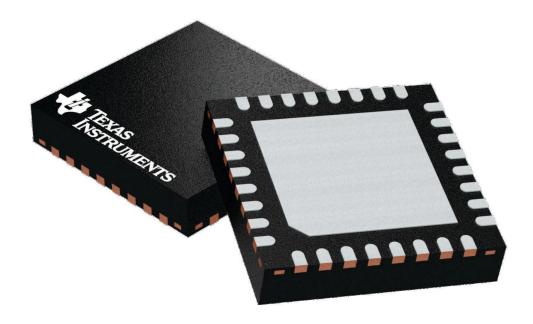


# \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS65263RHBR	VQFN	RHB	32	3000	346.0	346.0	33.0
TPS65263RHBT	VQFN	RHB	32	250	182.0	182.0	20.0

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



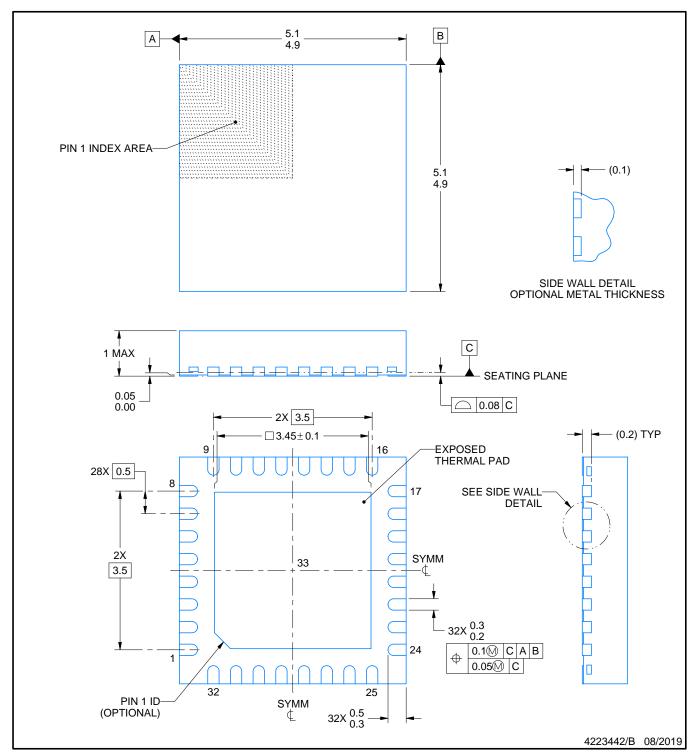
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4224745/A





PLASTIC QUAD FLATPACK - NO LEAD

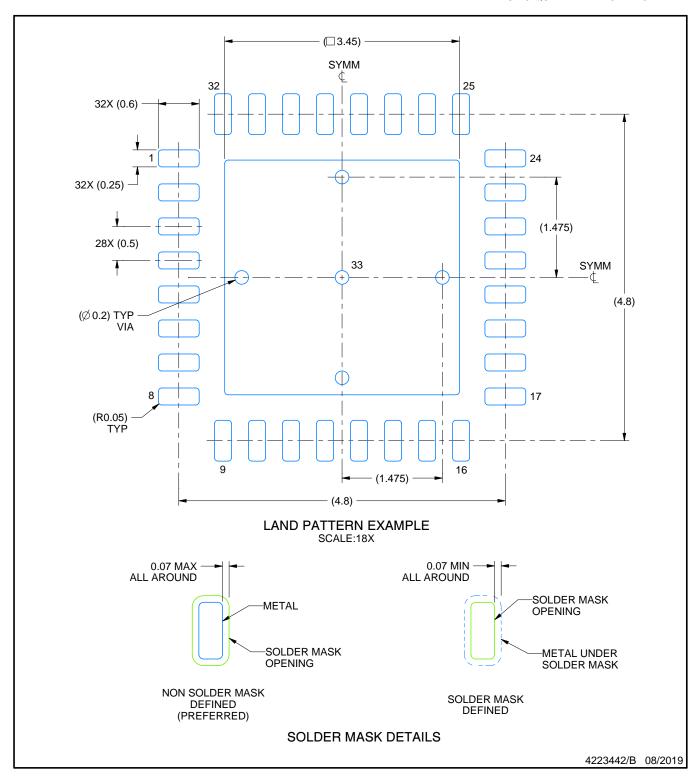


### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

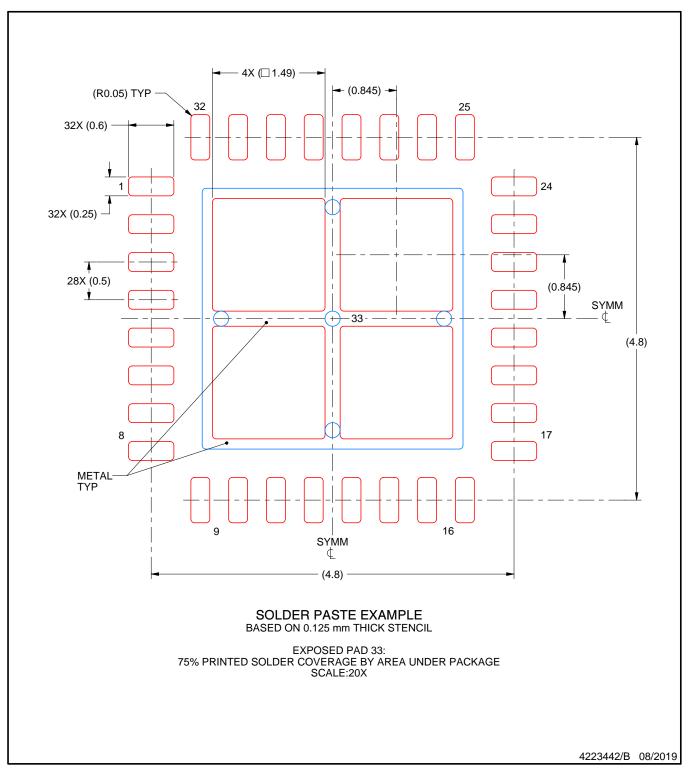


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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